Atty Docket No.: 266357US6	03-03-200	5		
FORM PTO-1595 06-04		U.S. DEPAI	RTMENT OF COMMERC	
To the Director of the United States Patent and To	10295243	8 original documents	or copy thereof.	
Name of conveying party(ies):     Yoichiro IINO  Additional name(s) of conveying party(ies) attached?	Name: Address	and address of receiving party(ies)  Sony Corporation  7-35, Kitashinagawa 6-chome Shinagawa-ku, Tokyo 141-0001 Japan	113013 U.S. PTO	
3. Nature of Conveyance:			<del>-</del> -	
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Execution Date: February 2, 2005	Addition	Additional name(s) and address(es) attached? ☐ Yes ■ No		
4. Application number(s) or patent number(s):				
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Name and address of party to whom correspondence concerning document should be mailed:		6. Total applications and patents involved: 1		
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**PATENT** REEL: 016308 FRAME: 0452

Docket Number:

ASSIGNMENT	•
WHEREAS, I, as a below named inventor, residing at the only one name is listed below) or a joint inventor (if plural names are listed DATA COMMUNICATING APPARATUS, DATA COMMUNICATION	d below) of certain new and useful improvements in
for which application for Letters Patent of the United States of America wa	s executed by me on the date indicated next to my name
AND WHEREAS, Sony Corporation, a Japanese corp Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desire said application disclosing the invention and in, to and under any Letters therefor in the United States and in any and all foreign countries;	ous of acquiring all interest in, to and under said invention,
NOW THEREFORE, in consideration of the sum of One the receipt and sufficiency of which are hereby acknowledged, I, as a sole of hereby assign, sell and transfer unto the said ASSIGNEE, its successors, as interest in the said invention, said application, including any divisions and Patent of the United States, and countries foreign thereto, which may be grarights and/or convention rights under the International Convention for the ProRelating to Patents, Designs and Industrial Models, and any other internate adheres, and to any other benefits accruing or to accrue to me with respendents in the United States and countries foreign thereto, and I hereby authorized United States Letters Patent to said ASSIGNEE, as the assignee of the	or joint inventor as indicated below, by these presents do signs, and legal representatives, the entire right, title and all continuations thereof, and in and to any and all Letters anted for said invention, and in and to any and all priority of tection of Industrial Property, Inter-American Convention cional agreements to which the United States of America et to the filing of applications for patents or securing of prize and request the Commissioner of Patents to issue the
And I further agree to execute all necessary or desirable and law ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and leand without further remuneration, in order to perfect title in said inventionable applications and Letters Patent of the United States and countries foreign to	egal representatives may from time-to-time present to me ion, modifications, and improvements in said invention,
And I further agree to properly execute and deliver and without fur papers for application for foreign patents, for filing subdivisions of said a reissues of any Letters Patent which may be granted for my aforesaid inven- prepare at its own expense;	pplication for patent, and or, for obtaining any reissue or
And I further agree that ASSIGNEE will, upon its request, be p relating to said application, said invention and said Letters Patent and leg accessible to me and will testify as to the same in any interference or litig	al equivalents in foreign countries as may be known and
And I hereby covenant that no assignment, sale, agreement or enc would conflict with this assignment and sale.	numbrance has been or will be made or entered into which
And I hereby authorize and request my attorney(s) of record in this application in the spaces that follow: Serial Number:	
This assignment executed on the dates indicated below.	
Yoichiro IINO	2 February 200#5
Name of first or sole inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of first or sole inventor	7 F./
Yoichiao Dino	2 February 2005
Signature of first or sole inventor	Date of this assignment

**RECORDED: 02/22/2005** 

PATENT REEL: 016308 FRAME: 0453